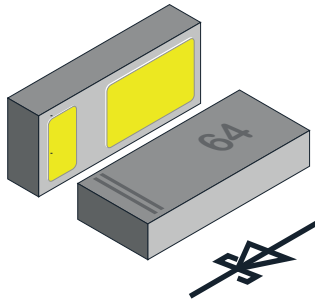


Schottky Rectifier Surface-Mount FlipKY® Gen 3



FEATURES

- Schottky diode for high-speed switching
- Very low dimensions:
1.4 mm x 0.6 mm x 0.29 mm
- 1 A forward current
- Low forward voltage drop (typ. 465 mV at 1000 mA)
- Low reverse current (< 15 μ A at 10 V)
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

LINKS TO ADDITIONAL RESOURCES



PARTS TABLE								
PART	GRADE	ORDERING CODE	CIRCUIT CONFIGURATION	PACKAGE NAME	TYPE MARKING	WEIGHT	TAPED UNITS PER REEL (8 mm TAPE ON 7" REEL)	MINIMUM ORDER QUANTITY
VSKY1040E6	AEC-Q101	VSKY1040E6HG4-08	Single	CLP1406-2L	64	0.57 mg	5000	5000

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		V_R	40	V
Forward continuous current		I_F	1000	mA
Surge forward current	Single pulse; 8.3 ms half sine wave	I_{FSM}	18	A

THERMAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to soldering point	Acc. JEDEC® JESD51-41	R_{thJS}	8	K/W
Maximum operating junction temperature		$T_j \text{ max.}$	150	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	-65 to +150	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	TYP.	MAX.	UNIT
Leakage current	$V_R = 10\text{ V}$	I_R	-	15	μA
Leakage current	$V_R = 40\text{ V}$	I_R	-	85	μA
Forward voltage	$I_R = 100\text{ mA}$	V_F	318	368	mV
Forward voltage	$I_R = 500\text{ mA}$	V_F	395	448	mV
Forward voltage	$I_R = 1000\text{ mA}$	V_F	465	515	mV
Diode capacitance	$V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_D	225	-	pF

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

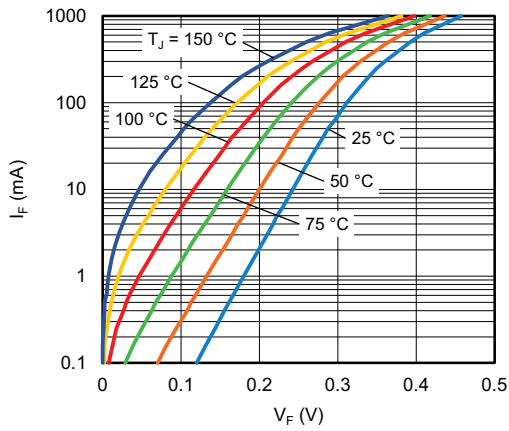


Fig. 1 - Typical Forward Current vs. Forward Voltage

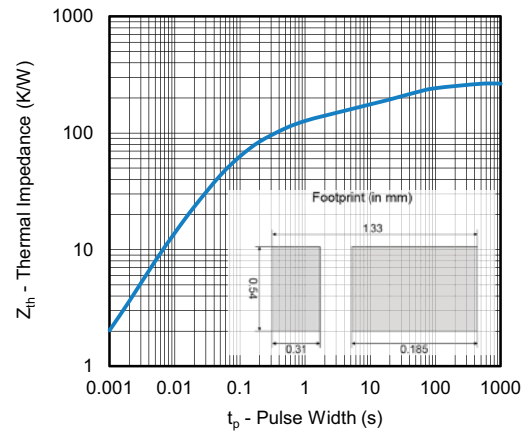


Fig. 4 - Typical Thermal Impedance vs. Time

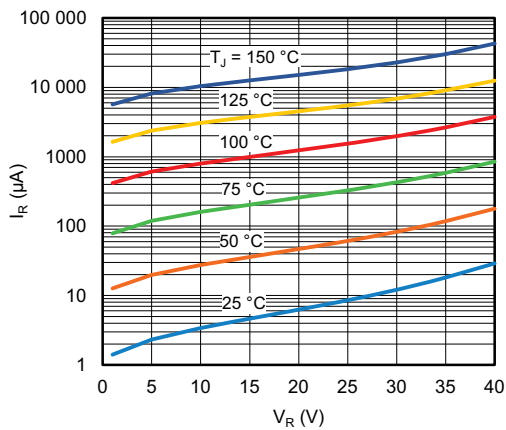


Fig. 2 - Typical Reverse Leakage Current vs. Reverse Voltage

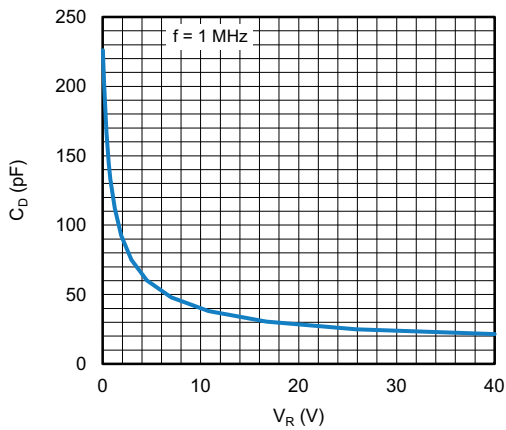
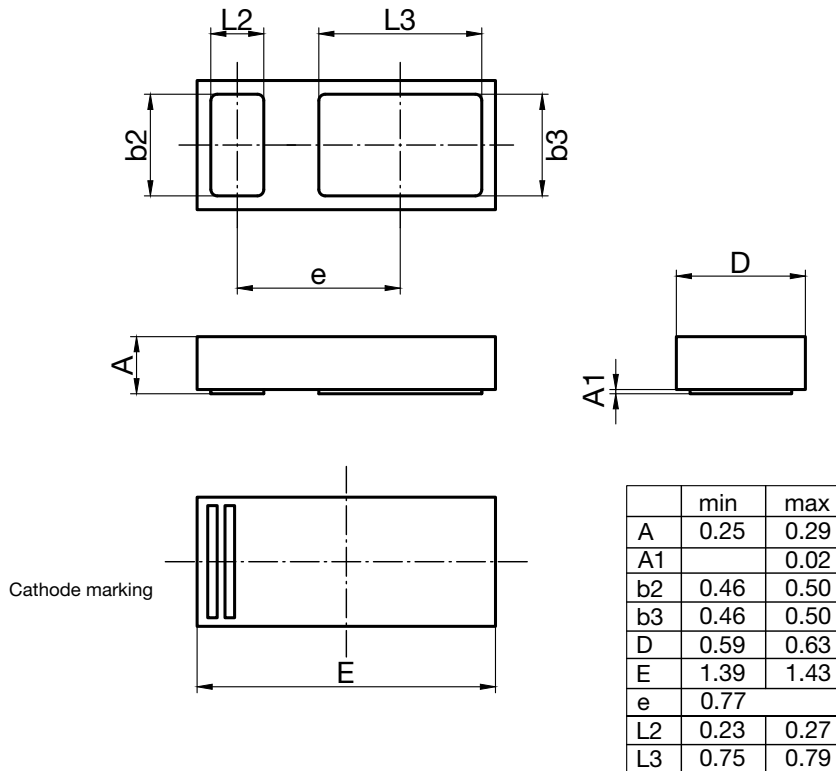


Fig. 3 - Typical Capacitance vs. Reverse Voltage

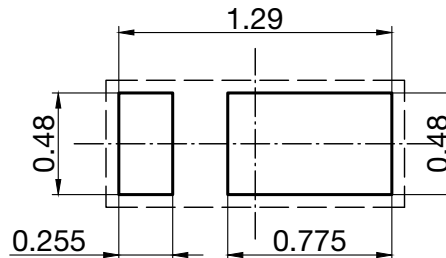


PACKAGE DIMENSIONS in millimeters: **CLP1406-2L**

Package = Chip Dimensions in mm



foot print recommendation:



Document no.:S8-V-3906.04-045 (4)
 Created - Date: 22. Jan. 2016
 Rev.1 - Date: 19. Dec. 2023
 23228

Footprint and soldering recommendation:

please see Application Note: www.vishay.com/doc?85917



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